

<b>Notice of References Cited</b>				Application No. <b>09/514,454</b>		Applicant(s) <b>Reiber et al.</b>	
				Examiner <b>Lynne Edmondson</b>		Group Art Unit <b>1725</b>	

  

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(See Manual of Patent Examining Procedure, Section 707.05(a).)

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